



**LIGHT**

**LIGHT ELECTRONICS CO., LTD.**

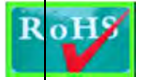
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LIG

**LIGHT ELECTRONICS CO., LTD.**

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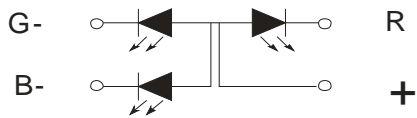
**Reliability Test Items And Conditions**

实验项目	参考标准	实验条件	时间	
		↔		

## Product design and operational recommendation

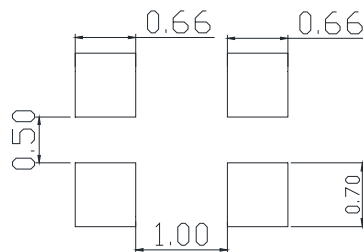
1 mm

Product design Unit: mm



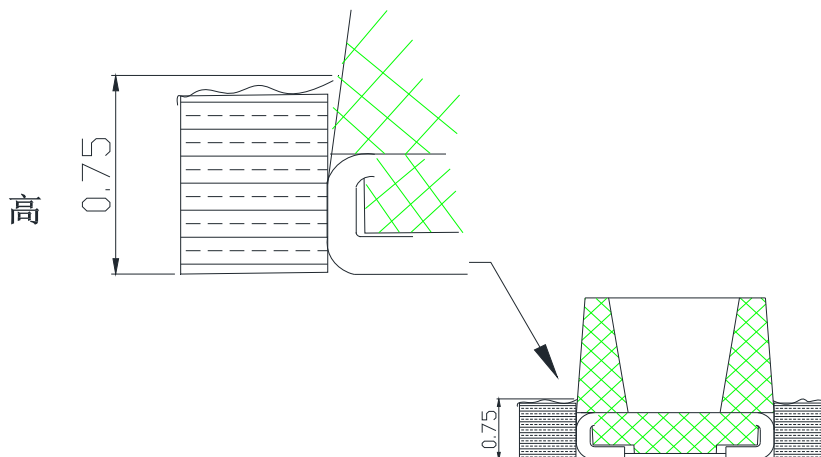
2 mm

Recommended soldering pad (Unit: mm)



3 0.75mm

Recommendation for glue filling: filling height must be higher than or equal to 0.75mm



## 1

### Packaging (1)

◇ Carrier Tape

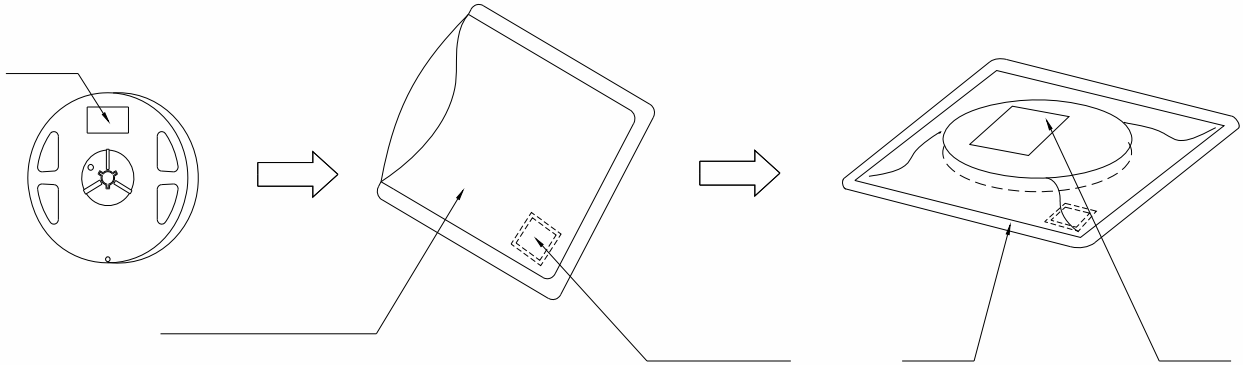
◇

## 2

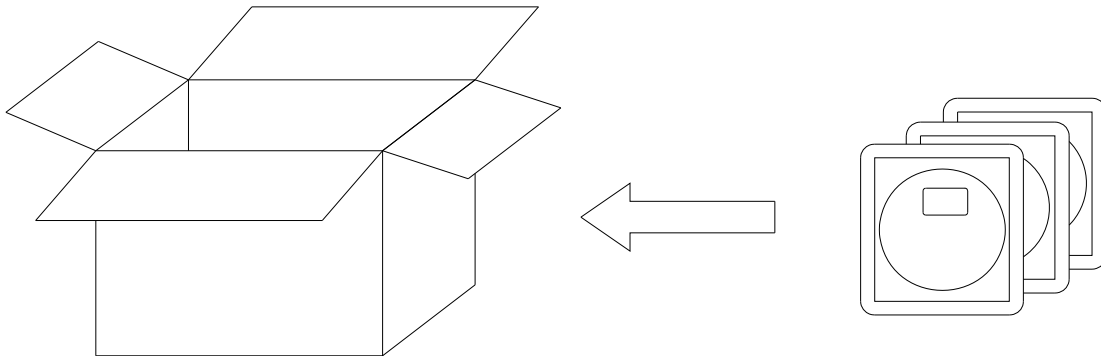
### Packaging( 2)





#### Moisture Proof and Anti-Electrostatic Foil Bag



#### Cardboard Box



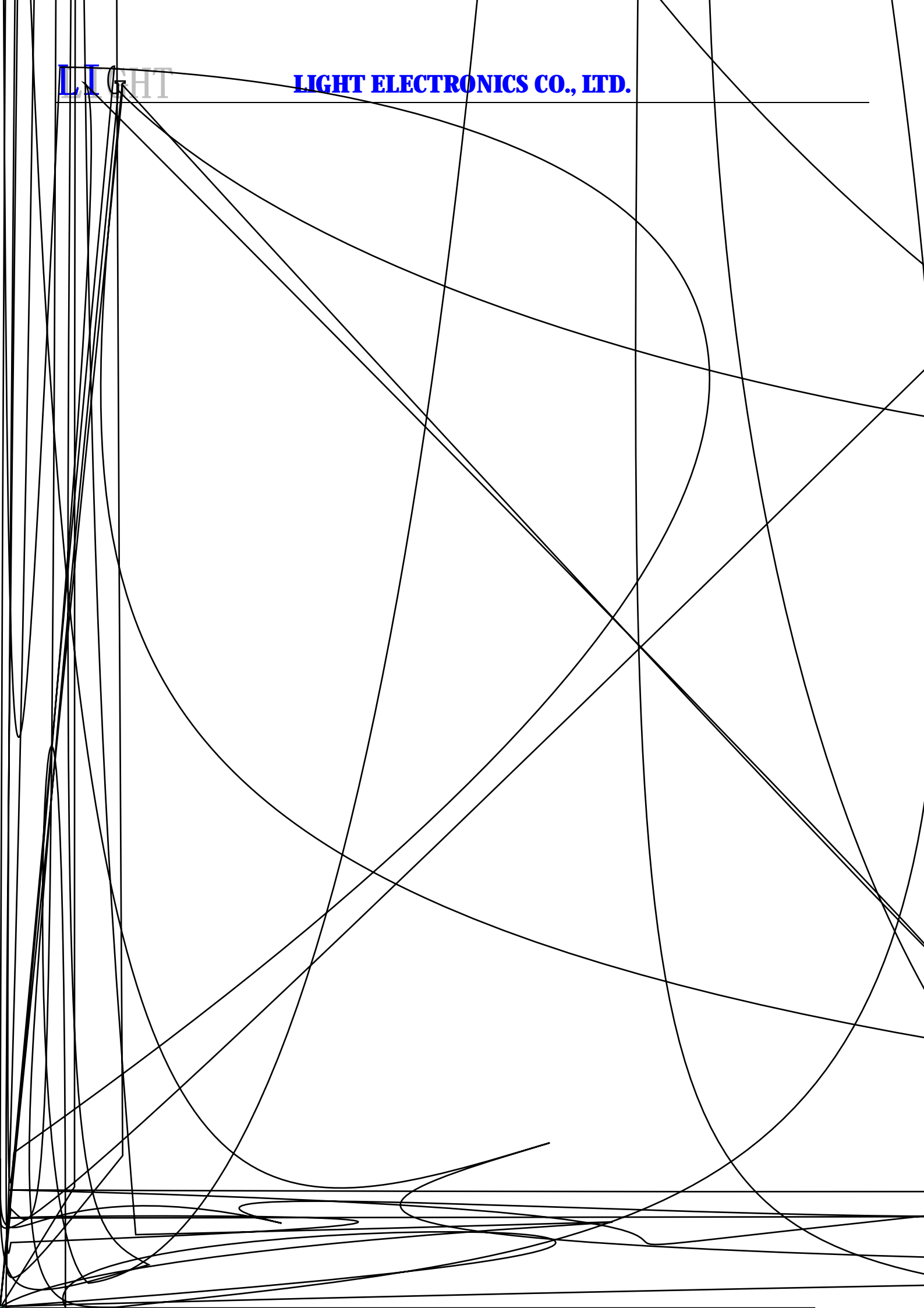
#### Label Explanation

<b>LIGHT</b>		
Light Electronics CO., LTD.		
TYPE NO.:	_____	 <small>LOT NO. :</small>
QUANTITY:	_____	
BIN:	_____	
DATE CODE:	_____	
REMARKS:	_____	




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## 2

### Guideline for Soldering (2)

## (1)

### Precautions (1)

1.

#### Storage

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2.

#### Static Electricity

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## (2)

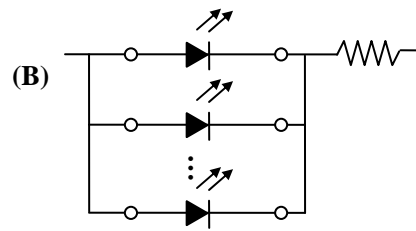
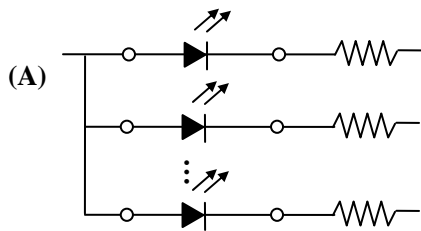
### Precautions (2)

3.

#### Design Consideration

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4.

#### Reverse voltage protection

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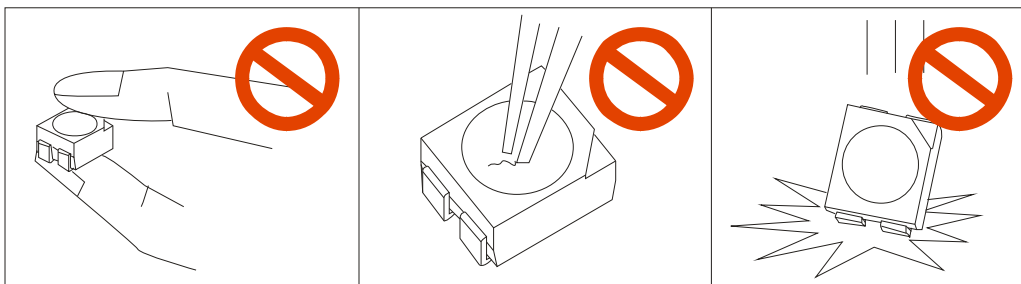
5.

**The safe temperature for LEDs working**

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6.

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